Audio DPDT Switch with Noise Suppression

Description

The NLAS6233 is a DPDT switch featuring Popless noise suppression circuitry designed to prevent pass through of undesirable transient signals known as pops. Intended for audio systems within portable applications, it provides protection against audible pops that are generated when switching between two different audio sources, such as an amplifier and a CODEC.

The NLAS6233 incorporates two double throw switches controlled by a single select line which allows the system controller to simultaneously switch between two sets of signal lines. The Popless noise suppression circuitry controls the ON and OFF times that define the time interval when switching between the normally open (NO) and normally closed (NC) terminals. This allows any pops to be dissipated within the system before the switch settles into a closed position.

The NLAS6233 operates off of a single supply voltage, V_{CC} , and is available in an ultra-thin UQFN10 package.

Features

- Popless Noise Suppression Circuitry
- OVT up to +4.5 V on Control Pin
- $R_{ON} < 0.5 \Omega$ Across BCC Range, Typical
- THD < 0.02 %, Typical
- Off Isolation = -70 dB, Typical
- Crosstalk Attenuation < -70 dB, Typical
- Ultra Small, Thin Package: 1.4 mm x 1.8 mm UQFN10
- This is a Pb-Free Device

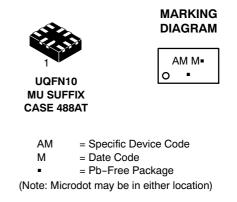
Typical Applications

• Cell Phones, PDAs, MP3 and Other Portable Media Players



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ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 8 of this data sheet.

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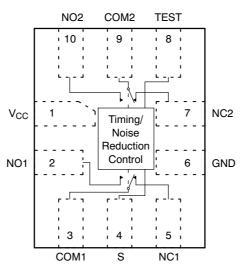


Figure 1. Pin Connections and Logic Diagram (Top View) NOTE: Pin 8 is for ATE use only, not intended for end customer use.

PIN ASSIGNMENT

PIN	FUNCTION
V _{CC}	Supply Voltage
GND	Ground
S	Control Input Select Line
TEST	ATE Test Pin
NC1, NO1, NC2, NO2	Independent Channels
COM1, COM2	Common Channels

TRUTH TABLE

S	NC1, NC2	NO1, NO2
0	ON	OFF
1	OFF	ON

MAXIMUM RATINGS

Symbol	Pins Rating		Value	Unit
V _{CC}	V _{CC}	Positive DC Supply Voltage	-0.5 to +5.5	V
V _{IS}	NOx, NCx, COMx	Analog Signal Voltage	-0.5 to V _{CC} + 0.5	V
V _{IN}	S	Control Input Voltage	-0.5 to +5.5	V
I _{IS_CON}	NOx, NCx, COMx	Analog Signal Continuous Current-Closed Switch	±300	mA
I _{IS_PK}	NOx, NCx, COMx	Analog Signal Continuous Current 10% Duty Cycle	±500	mA
I _{IN}	S	Control Input Current	±20	mA
Ts	Ts	Storage Temperature	-65 to +150	°C

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

RECOMMENDED OPERATING CONDITIONS

Symbol	Pins	Parameter	Min	Max	Unit
V _{CC}	V _{CC}	Positive DC Supply Voltage	2.7	4.5	V
V _{IS}	NOx, NCx, COMx	Analog Signal Voltage	GND	V _{CC}	V
V _{IN}	S	Control Input Voltage (OVT Protection)	GND	4.5	V
T _A		Operating Temperature Range	-40	+85	°C
t _r , t _f		Input Rise or Fall Time, S $V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$	0	10	ns/V

DC ELECTRICAL CHARACTERISTICS

CONTROL INPUT (Typical: T = 25°C, V_{CC} = 3.3 V)

					-40	0°C to +85	S°C	
Symbol	Pins	Parameter	Test Conditions	V _{CC} (V)	Min	Тур	Max	Unit
V _{IH}	S	Minimum High-Level Input Voltage, Select Input		2.7 4.2	1.4 2.0	-	-	V
V _{IL}	S	Maximum Low-Level Input Voltage, Select Input		2.7 4.2	-	-	0.7 0.8	V
I _{IN}	S	Control Input Leakage Current	V _{IS} = GND	2.7-4.5	-	±100	±1000	nA

SUPPLY CURRENT AND LEAKAGE (Typical: T = 25°C, V_{CC} = 3.3 V, V_{IN} = V_{CC} or GND)

					-40)°C to +85	5°C	
Symbol	Pins	Parameter	Test Conditions	V _{CC} (V)	Min	Тур	Max	Unit
I _{CC}	V _{CC}	Quiescent Supply Current	$V_{IS} = V_{CC}$ or GND; $I_D = 0$ A	2.7 - 4.5	-	<100	1000	nA
I _{NC(OFF)} , I _{NO(OFF)}	NCx, NOx	OFF State Leakage Current	V _{COM} = 4.5 V V _{NO} , V _{NC} = 1.0 V	2.7 - 4.5	-	±10	±1000	nA
I _{OFF}		Power OFF Leakage Current	V _{IS} = GND	0	-	±10	±1000	nA

ON RESISTANCE (Typical: T = 25° C, V_{CC} = 3.3 V)

					-40	0°C to +85	S°C	
Symbol	Pins	Parameter	Test Conditions	V _{CC} (V)	Min	Тур	Max	Unit
R _{ON}		On-Resistance	$\label{eq:VIN} \begin{array}{l} V_{IN} = V_{IL} \text{ or } V_{IN} = V_{IH} \\ V_{IS} = 0 \text{ to } V_{CC}; \\ I_{IS} = 100 \text{ mA} \end{array}$	2.7 4.2	-	0.45 0.40	0.60 0.55	Ω
R _{FLAT}		On-Resistance Flatness	$V_{IS} = 0$ to V_{CC} ; $I_{IS} = 100$ mA	2.7 4.2	-	0.12 0.15	0.16 0.19	Ω
ΔR_{ON}		On-Resistance Match Between Channels	$V_{IS} = 0$ to V_{CC} ; $I_{IS} = 100$ mA	2.7 4.2	-	0.16 0.19	0.24 0.23	Ω

AC ELECTRICAL CHARACTERISTICS

					-40	0°C to +85	5°C	
Symbol	Pins	Parameter	Test Conditions	V _{CC} (V)	Min	Тур	Max	Unit
t _{ON}	-	Turn-ON Time (Figures 2, 3, 12)		2.7-4.5		17		ns
t _{OFF}	-	Turn-OFF Time (Figures 2, 3, 13)		2.7-4.5		9.0		ns
t _{BBM}	-	Minimum Break Before Make Time (Figure 14)	V _{IS} = 3.0, typ @ V _{CC} = 3.6 V	3.4-4.2		175		ms
BW	-	-3 dB Bandwidth	V _{IS} = 0 dB	2.7-4.5		36		MHz

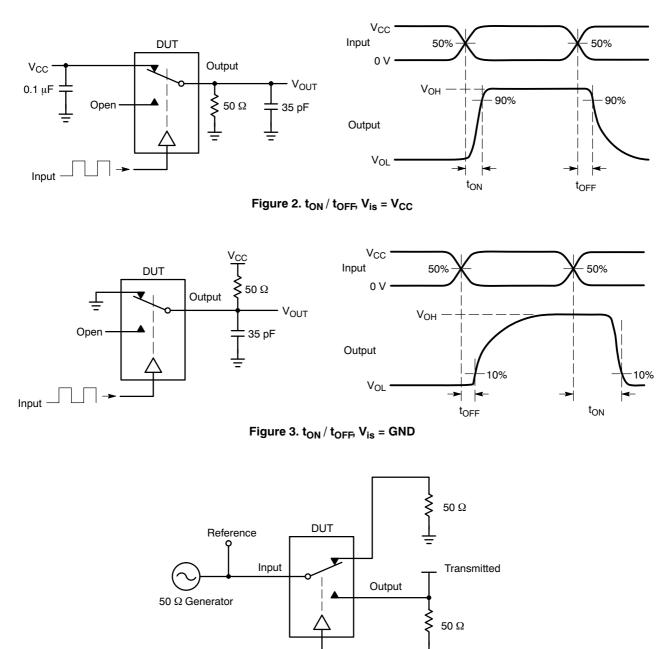
TIMING/FREQUENCY (Typical: T = 25°C, V_{CC} = 3.3 V, R_L = 50 Ω , C_L = 35 pF, f = 1 MHz)

ISOLATION (Typical: T = 25°C, V_{CC} = 3.3 V, R_L = 50 $\Omega,$ C_L = 5 pF)

					-40	0°C to +85	ΰ°C	
Symbol	Pins	Parameter	Test Conditions	V _{CC} (V)	Min	Тур	Max	Unit
O _{IRR}	NOx	OFF-Isolation	V _{IS} = 1.0 V _{RMS} , f = 100 kHz	2.7-4.5		-70		dB
XTALK	COM 1 to COM 2	Crosstalk	V _{IS} = 1.0 V _{RMS} , f = 100 kHz	2.7-4.5		-98		dB
THD	-	Total Harmonic Distortion	$ \begin{array}{l} R_{L} = 600 \ \Omega, \\ V_{COMn} = 2.0 \ V_{p-p} \end{array} $	3.0		0.02		%

CAPACITANCE (Typical: T = 25°C, V_{CC} = 3.3 V, R_L = 50 Ω , C_L = 5 pF, f = 1 MHz)

					-40	0°C to +85	5°C	
Symbol	Pins	Parameter	Test Conditions	V _{CC} (V)	Min	Тур	Max	Unit
C _{IN}	S	Select Input Capacitance		0		2.5		pF
C _{OFF}	NOx	OFF-Capacitance	V _{IS} = 3.3 V, S = 0 V	2.7-4.5		45		pF
C _{ON}	COMx to NCx	ON-Capacitance	S = 0 V	2.7-4.5		110		pF

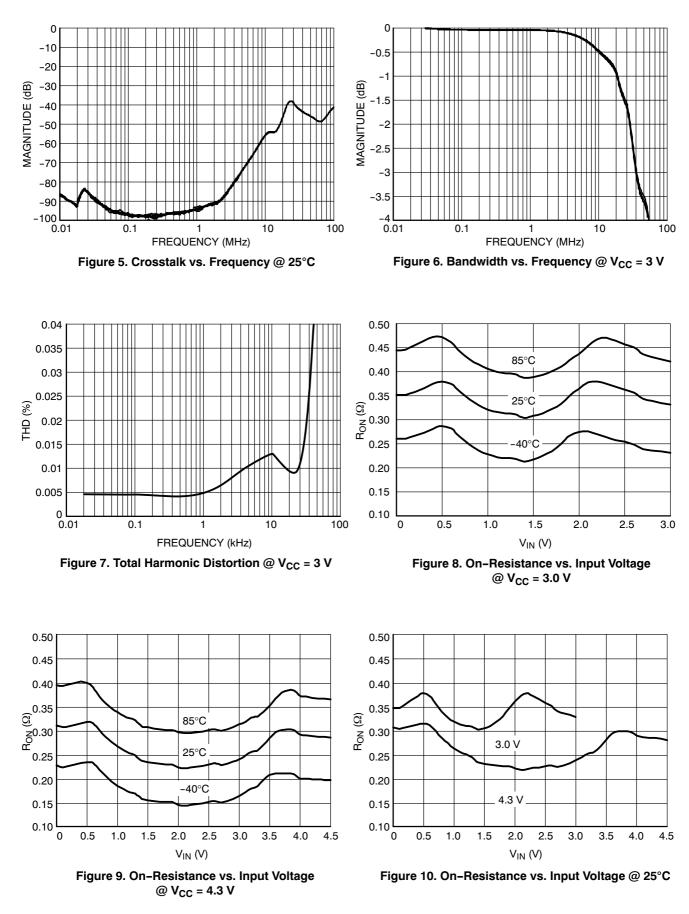


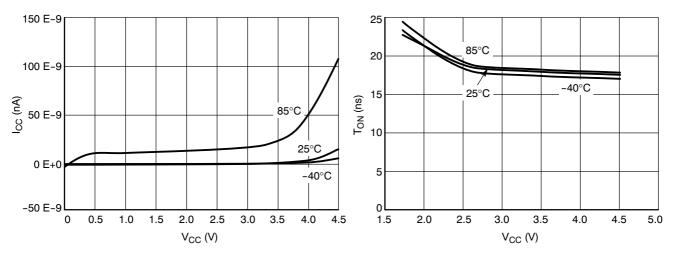
Channel switch control/s test socket is normalized. Off isolation is measured across an off channel. On loss is the bandwidth of an On switch. V_{ISO} , Bandwidth and V_{ONL} are independent of the input signal direction.

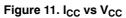
 $V_{ISO} = Off Channel Isolation = 20 Log \left(\frac{V_{OUT}}{V_{IN}}\right)$ for V_{IN} at 100 kHz $V_{ONL} = On Channel Loss = 20 Log \left(\frac{V_{OUT}}{V_{IN}}\right)$ for V_{IN} at 100 kHz to 50 MHz

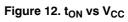
Bandwidth (BW) = the frequency 3 dB below V_{ONL} V_{CT} = Use V_{ISO} setup and test to all other switch analog input/outputs terminated with 50 Ω

Figure 4. Off-Channel Isolation/On Channel Loss (BW)/Crosstalk (On Channel to Off Channel)/VONL









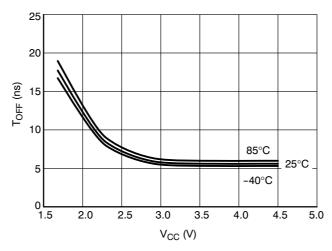


Figure 13. t_{OFF} vs V_{CC}

Popless Implementation on the NLAS6233

Audio sources such as amplifiers or CODECs can generate undesirable, transient voltage spikes when powering up and down. Those voltage spikes can be translated into current surges and ultimately lead to audible pop noises in the speaker if not diverted or suppressed. The NLAS6233 includes popless noise suppression circuitry designed to prevent such undesirable pops from propagating through to the speaker. This feature is realized through a deliberate increase in the Break-Before-Make time, t_{BBM}, and is useful in applications where a switch is used to alternate between two different audio sources.

When the signal from the common pin is removed from one terminal, the switch waits an extended amount of time before connecting to the opposite terminal. The time interval for t_{BBM} is a function of the supply voltage of the switch, V_{CC} . Figure 14 shows the relationship of t_{BBM} for each V_{CC} value within the recommended operating voltage range.

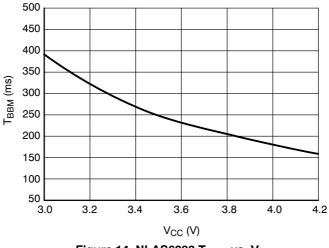


Figure 14. NLAS6233 T_{BBM} vs. V_{CC}

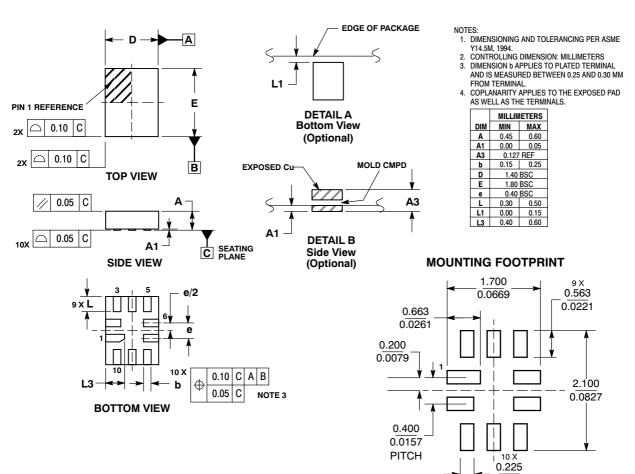
DEVICE ORDERING INFORMATION

Device	Package	Shipping [†]
NLAS6233MUTBG	UQFN10 (Pb-Free)	3000/Tape & Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

PACKAGE DIMENSIONS

UQFN10, 1.4x1.8, 0.4P CASE 488AT-01 ISSUE A



*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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SCALE 20:1 (mm inches)

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